AUTOMOTIVI GRADE

ROHS

HALOGEN FREE



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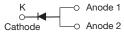
Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

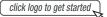
Ultra Low $V_F = 0.50 \text{ V}$ at $I_F = 6 \text{ A}$



SMPC (TO-277A)



DESIGN SUPPORT TOOLS





PRIMARY CHARACTERISTICS			
I _{F(AV)}	12 A		
V _{RRM}	100 V		
I _{FSM}	200 A		
V _F at I _F = 15 A (125 °C)	0.61 V		
T _J max.	175 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V12PM10	UNIT	
Device marking code		12M10		
Maximum repetitive peak reverse voltage	V _{RRM}	100	V	
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	12	А	
	I _{F(AV)} (2)	4.2		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	200	А	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended pad area
- (3) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta,IA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 6 A	T _A = 25 °C	V _F ⁽¹⁾	0.57	-	V
	I _F = 12 A			0.69	0.75	
	I _F = 6 A	- T _A = 125 °C		0.50	-	
	I _F = 12 A			0.61	0.66	
Reverse current	V _R = 70 V	T _A = 25 °C	I _R ⁽²⁾	0.02	-	
		T _A = 125 °C		2.5	-	mA
	I V _R = 100 V ⊢	T _A = 25 °C		C IR '/ -	0.20	IIIA
		T _A = 125 °C		5	16	
Typical junction capacitance	4.0 V, 1 MHz		CJ	1200	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL V12PM10		UNIT
Tuning thermal registance	R _{0JA} ⁽¹⁾⁽²⁾ 75		°C/W
Typical thermal resistance	R _{0JM} (3)	4	C/VV

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- $^{(3)}$ Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V12PM10-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V12PM10-M3/I	0.10	1	6500	13" diameter plastic tape and reel	
V12PM10HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel	
V12PM10HM3/I (1)	0.10	1	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

100



10.0

9.0

8.0

7.0

6.0

5.0 4.0

3.0 2.0 1.0 0

Average Power Loss (W)

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 $T_J = \overline{175 \, ^{\circ}C}$

T_{.1} = 150 °C

T_J = 125 °C

T_J = 100 °C

 $T_J = 25 \,^{\circ}C$

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

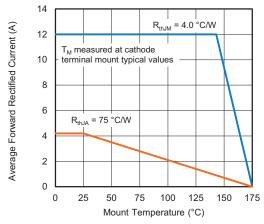


Fig. 1 - Maximum Forward Current Derating Curve

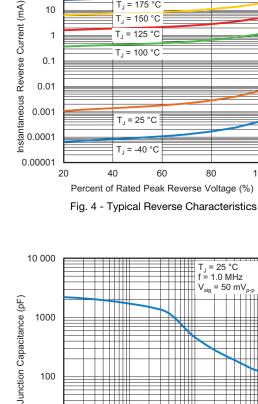
D = 0.5

D = 0.3

D = 0.2

D = 0.8

D = 1.0



100

10

1

0.1

0.01

0.001

0 6 8 10 12 Average Forward Current (A) Fig. 2 - Forward Power Loss Characteristics

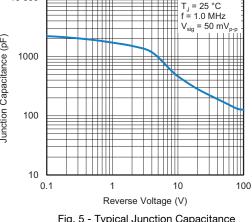


Fig. 5 - Typical Junction Capacitance

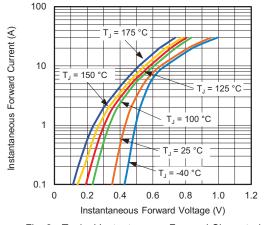


Fig. 3 - Typical Instantaneous Forward Characteristics

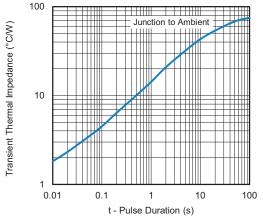
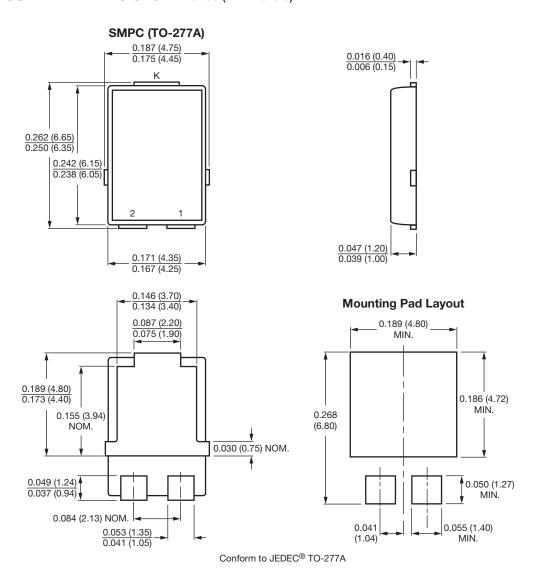


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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